ROHS

LEADER TIME SRL

PRODUCT SPECIFICATION

16*2 Characters COB LCD MODULE MODEL: LT-1602F1-295 Ver:1.0

< >> Finally Specification

| | CUSTOMER'S APPROVAL | | | |
|-----------|---------------------|-------|--|--|
| CUSTOMER: | | | | |
| SIG | NATURE: | DATE: | | |
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| APPROVED | РМ | PD | PREPARED |
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Prepared By: LEADER TIME SRL

VIA MONS. PROSDOCIMI, 27 36042 BREGANZE (VI)

• This specification is subject to change without notice. Please contact LT or it's representative before designing your product based on this specification.

Revision Status

| Version | Revise Date | Page | Content | Modified By |
|---------|-------------|------|--------------|-------------|
| VER 1.0 | 2011.07.01 | | First Issued | |
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1. Features

The features of LCD are showed as follows

* Display mode : STN/ Yellow-Green/Transflective/Positive

* Controller IC :SPLC780D1_003(English &European)

* Display format : 16X2 Characters

* Interface Input Data : 4bit or 8 bit MPU

* Driving Method : 1/16Duty, 1/5Bias

* Viewing Direction : 6 O'clock

* Backlight : LED /Yellow-Green

*Sample NO. : EC1602C5SBX6B-B4_01/20110630

2. MECHANICAL SPECIFICATIONS

| Item | Specification | Unit |
|-----------------------|---------------------------|------|
| Module Size | 80(W) x 36(H) x 9.5MAX(D) | mm |
| Viewing Area | 64.5(W) x16(H) | mm |
| Activity Display Area | 56.21(W) x 11.5 (H) | mm |
| Character Font | 5x8 Dots | - |
| Character Size | 2.96(W) x 5.56(H) | mm |
| Character Pitch | 3.55(W) x 5.94(H) | mm |
| Dot Size | 0.56(W) x0.66(H) | mm |

3. ELECTRICAL SPECIFICATIONS

3-1 ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C)

| Item | Symbol | Min | Max | Unit |
|------------------------------|-----------|--------|---------|------|
| Supply Voltage For Logic | Vdd | 0.3 | 7 | V |
| Supply Voltage For LCD Drive | V_{LCD} | VDD-10 | VDD+0.3 | V |
| Input Voltage | Vin | -0.3 | VDD+0.3 | V |
| Operating Temp. | Тор | -20 | +70 | °C |
| Storage Temp. | Tst | -30 | +80 | °C |

^{*.} NOTE: The response time will be extremely slow when the operating temperature is around -10 $^{\circ}$ C, and the back ground will become darker at high temperature operating.

3-2 ELECTICAL CHARACTERISTICS

| Item | | Symbol | Test Condition | Min. | Тур. | Max. | Unit |
|----------------------|-----------|-----------------------------------|-------------------|------|------|------|----------|
| Logic supply Voltage | | V _{DD} – V _{ss} | Ta = 25 °C | 4.5 | 5 | 5.5 | \ |
| LCD Dri | LCD Drive | | | 4.2 | 4.5 | 4.8 | V |
| Input Voltage | "H" Level | V _{IH} | VDD=5V ± 10% | 2.2 | 1 | VDD | \ |
| ļ | "L" Level | V _{IL} | | -0.3 | - | 0.6 | V |
| Frame Frequency | | f _{FLM} | | - | - | 84.4 | Hz |
| Current Cons | umption | I _{DD} | | - | 1.96 | ı | mA |

3-3 BACKLIGHT

3-3-1. Absolute Maximum Ratings

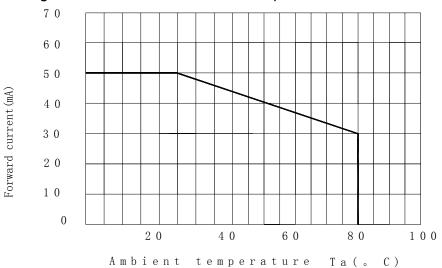
| Item | Symbol | Condition | Min. | Тур. | Max. | Unit |
|-------------------|--------|------------|------|------|------|------|
| Forward Current | IF | | - | 30 | - | mA |
| Reverse Voltage | VR | Ta = 25 °C | - | - | 10 | V |
| Power Dissipation | PD | | - | - | 135 | mW |

3-3-2. Electrical-optical Characteristics

| Item | Symbol | Condition | Min. | Тур. | Max. | Unit |
|----------------------------|--------|------------|------|------|------|-------------------|
| Forward Voltage | VF | lf=30mA | 3.8 | 4.2 | 4.6 | ٧ |
| Average Luminous Intensity | lv | Ta = 25 °C | 30 | - | - | cd/m ² |
| Peak Wave length | λр | | 567 | 572 | 577 | nm |

3-4-3. Backlighting temperature curve

The brightness is measured without LCD panel



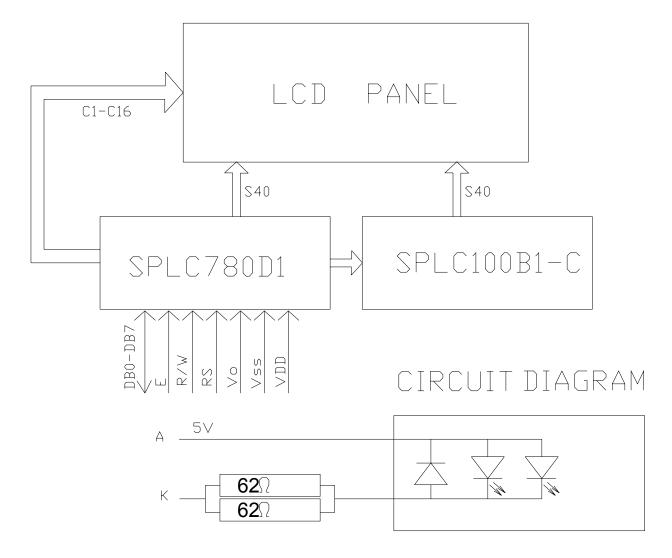
For operation above 25 °C,The lfm & Pd must be derated , the current derating is -0.36mA/ °C for DC drive and -0.86mA/ °C for Pulse drive ,the Power dissipation is -0.75mW/ °C.The product working current must not more than the 60% of the lfm or lfp according to the working temperature.

4. TERMINAL FUNCTIONS AND BLOCK DIAGRAM

4-1 INTERFACE PIN FUNCTION DESCRIPTION

| PIN NO. | SYMBOL | FUNCIONS |
|---------|---------|---|
| 1 | VSS | Ground |
| 2 | VDD | Supply voltage for logical circuit |
| 3 | V0 | Supply voltage for LCD driving |
| 4 | RS | A signal for selecting registers. 1: Data Register (for read and write) 0: Instruction Register (for write) |
| 5 | R/W | A signal for selecting read or write actions.1: Read, 0: Write. |
| 6 | E | A enable signal for reading or writing data. |
| 7-14 | DB0~DB7 | 8 Bit Data Bus |
| 15 | K | Backlight (-) |
| 16 | Α | Backlight (+5V) |

4-2 BLOCK DIAGRAM

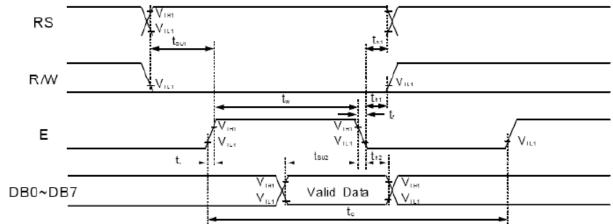


5. TIMING CHARACTERISTICS

5 - 1 Write mode

| Mode | Characteristic | Symbol | Min. | Тур. | Max. | Unit |
|--------------------------------|---------------------------|--------------------------------|------|------|------|------|
| | E Cycle Time | tc | 500 | - | - | |
| | E Rise / Fall Time | t _R ,t _F | - | - | 20 | |
| | E Pulse Width (High, Low) | t _w | 230 | - | - | |
| Write Mode (Refer to Fig-1) | R/W and RS Setup Time | t _{su1} | 40 | - | - | ns |
| (Iteleritering I) | R/W and RS Hold Time | t _{H1} | 10 | - | - | |
| | Data Setup Time | t _{su2} | 80 | - | - | |
| | Data Hold Time | t _{H2} | 10 | - | - | |

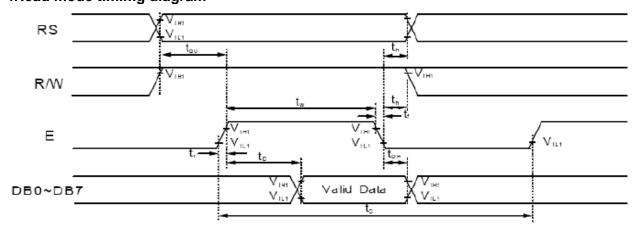
5-2 Write mode timing diagram



5.3 Read mode

| 5.5 INEau IIIOUE | | | | | | |
|-------------------------------|---------------------------|---------------------------------|-----|---|-----|----|
| | E Cycle Time | t _c | 500 | - | - | |
| | E Rise / Fall Time | t _R , t _F | - | - | 20 | |
| | E Pulse Width (High, Low) | t _w | 230 | - | - | |
| Read Mode (Refer to Fig-2) | R/W and RS Setup Time | t _{su} | 40 | - | - | ns |
| (Neier to rig-2) | R/W and RS Hold Time | t _H | 10 | - | - | |
| | Data Output Delay Time | t _D | - | - | 120 | |
| | Data Hold Time | t _{DH} | 5 | - | - | |

5-4Read mode timimg diagram



6. COMMAND LIST

| Instruction | | | | Inst | ructi | on C | ode | | | | Description | Execution time (fosc= |
|----------------------------------|----|-----|-----|------|-------|------|-----|-----|-----|-----|---|-----------------------|
| instruction | RS | R/W | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | Description | 270 kHz) |
| Clear Display | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | Write "20H" to DDRAM and set DDRAM address to "00H" from AC | 1.53 ms |
| Return Home | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | - | Set DDRAM address to '00H' from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed. | 1.53 ms |
| Entry Mode Set | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | I/D | SH | Assign cursor moving direction and enable the shift of entire display. | 39 µs |
| Display ON/ OFF Control | 0 | 0 | 0 | 0 | 0 | 0 | 1 | D | С | В | Set display(D), cursor(C), and blinking of cursor(B) on/off control bit. | 39 µs |
| Cursor or Display Shift | 0 | 0 | 0 | 0 | 0 | 1 | s/c | R/L | - | - | Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data. | 39 µs |
| Function Set | 0 | 0 | 0 | 0 | 1 | DL | N | F | - | - | Set interface data length (DL: 8-bit/4-bit), numbers of display line (N: 2-line/1-line) and, display font type (F:5×11dots/5×8 dots) | 39 µs |
| Set CGRAM Address | 0 | 0 | 0 | 1 | AC5 | AC4 | AC3 | AC2 | AC1 | AC0 | Set CGRAM address in address counter. | 39 μs |
| Set DDRAM Address | 0 | 0 | 1 | AC6 | AC5 | AC4 | AC3 | AC2 | AC1 | AC0 | Set DDRAM address in address counter. | 39 µs |
| Read Busy Flag and Address | 0 | 1 | BF | AC6 | AC5 | AC4 | AC3 | AC2 | AC1 | AC0 | Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read. | 0 μs |
| Write Data to RAM | 1 | 0 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Write data into internal RAM (DDRAM/CGRAM). | 43 μs |
| Read Data from RAM | 1 | 1 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Read data from internal RAM (DDRAM/CGRAM). | 43 μs |

* "-". dont care

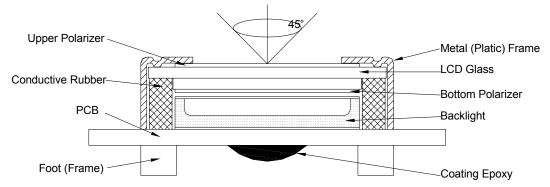
NOTE: When an MPU program with checking the Busy Flag(DB7) is made, it must be necessary 1/2Fosc is necessary for executing the next instruction by the falling edge of the 'E' signal after the Busy Flag (DB7) goes to "Low".

7. CHARACTER GENERATOR ROM

| Upper | | | | | | | | | | | | - 6 | | | | |
|-------------------------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| 4 bit Lower 4 bit | LLLL | LLLH | LLHL | LLHH | LHLL | LHLH | LHHL | LHHH | HLLL | HLLH | HLHL | HLHH | HHLL | нніл | нннг | нннн |
| LLLL | | | | | | | | | | | | | | | | |
| LLLH | | | | | | | | | | | | | | | | |
| LLHL | | | | | | | | | | | | | | | | |
| ггнн | | | Ħ | | | | | | | | | | | | | |
| LHLL | | | | | | | | | | | | | | | | |
| LHLH | | | | | | | | | | | | | | | | |
| гннг | | | | | | | | | | | | | | | | |
| гннн | | | | | | | | | | | | | | | | |
| HLLL | | | | | | | | | | | | | | | | |
| нггн | | | | | | | | | | | | | | | | |
| нгнг | | | | | | | | | | | | | | | | |
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8. QUALITY SPECIFICATIONS

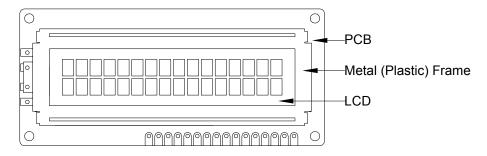
- 8 1. LCM Appearance and Electric inspection Condition
- 1. Inspection will be done by placing LCM 30cm away from inspector's eyeballs under normal illumination.



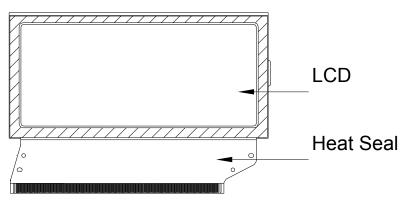
2. View Angle: with in 45° around perpendicular line.

8-2. Definition

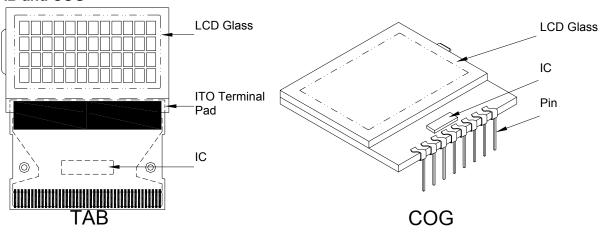
1. COB



2. Heat Seal



3. TAB and COG



8-3. Sampling Plan and Acceptance

1. Sampling Plan

MIL - STD - 105E (||) ordinary single inspection is used.

2.Acceptance

Major defect: AQL = 0.65% Minor defect: AQL = 1.5%

8-4. Criteria

1.COB

| Defect | Inspection Item | Inspection Standards | | | | |
|--------|-------------------------------|--|--------|--|--|--|
| Major | PCB copper flakes peeling off | Any copper flake in viewing Area should be greater than 1.0mm ² | Reject | | | |
| Major | Height of coating epoxy | Exceed the dimension of drawing | Reject | | | |
| Major | Void or hole of coating epoxy | Expose bonding wire or IC | Reject | | | |
| Major | PCB cutting defect | Exceed the dimension of drawing | Reject | | | |

2.SMT

| 2.SMT | | | |
|--------|---|---------------------------------|------------------|
| Defect | Inspection Item | Inspection Standa | ards |
| Minor | Component marking not readable | | Reject |
| Minor | Component height | Exceed the dimension Of drawing | Reject |
| Major | Component solder defect (missing, extra, wrong component or wrong orientation | | Reject |
| Minor | Component position shift component soldering pad | X < 3/4Z Y > 1/3D | Reject Reject |
| Minor | Component tilt component soldering pad | Y > 1/3D | Reject |
| Minor | Insufficient solder component PAD PCB | θ ≤ 20° | Reject |

3. Metal (Plastic) Frame

| Defect | Inspection Item | Inspection Standards | | | | |
|--------|--------------------------|--|---|------------------------------|--|--|
| Major | Crack / breakage | Any | /where | Reject | | |
| | | W | L | Acceptable of Scratch | | |
| | | w<0.1mm | Any | Ignore | | |
| | | 0.1 <u><</u> w<0.2mm | L <u><</u> 5.0mm | 2 | | |
| Minor | Frame Scratch | 0.2 <u><</u> w<0.3mm | L <u><</u> 3.0mm | 1 | | |
| | | w <u>></u> 0.3mm | Any | 0 | | |
| | | with distance gi | e criteria applicable reater than 5mm. on the back sid ignored . | | | |
| | | | | Acceptable of Dents / Pricks | | |
| | | Φ< | 2 | | | |
| | Frame Dent , Prick | 1.0< | 1 | | | |
| Minor | $\Phi = \frac{L + W}{2}$ | 1.51 | 0 | | | |
| | 2 | Note: 1. Above criteria applicable to any two dents / pricks with distance greater than 5mm 2. Dent / prick on the back side of frame (not visible) can be ignored | | | | |
| Minor | Frame Deformation | Exceed the dimension of drawing | | | | |
| Minor | Metal Frame Oxidation | | Any rust | | | |

4. Flexible Film Connector (FFC)

| Defect | Insp | ection Item | Inspection Standa | rds | | |
|----------|--|--------------------------|---------------------------------------|--------|----------------------|------------|
| Minor | Tilted soldering | | Tilted soldering Within the angle +5° | | Within the angle +5° | Acceptable |
| Minor | Uneven s | older joint /bump | | Reject | | |
| | | | Expose the conductive line | Reject | | |
| Minor | Hole | $\Phi = \frac{L + W}{2}$ | Ф > 1.0mm | Reject | | |
| Minor | Position shift | | Y > 1/3D | Reject | | |
| IVIIIIOI | ************************************** | | X > 1/2Z | Reject | | |

5. Screw

| Defect Inspection Item | | Inspection Standards | | | | |
|------------------------|----------------------|----------------------------------|--------|--|--|--|
| Major | Screw missing/loosen | | Reject | | | |
| Minor | Screw oxidation | Any rust | Reject | | | |
| Minor | Screw deformation | Difficult to accept screw driver | Reject | | | |

6. Heatseal 、TCP 、FPC

| Defect | Inspection Item | Inspection Standards | | | |
|-----------|----------------------------------|-----------------------------|--------|--|--|
| Major | Scratch expose conductive layer | | Reject | | |
| Minor | HS Hole $\Phi = \frac{L + W}{2}$ | Ф> 0.5mm | Reject | | |
| Major | Adhesion strength | Less than the specification | Reject | | |
| Minor | Position shift | Y > 1/3D | Reject | | |
| IVIII IOI | X | X > 1/2Z | Reject | | |
| Major | Conductive line break | | Reject | | |

7. LED Backing Protective Film and Others

| Defect | Inspection Item | Inspection Standards | | | | |
|--------|----------------------|--|--------|--|--|--|
| | | Acceptable number of units | | | | |
| | | Ф <u><</u> 0.10mm | Ignore | | | |
| | | 0.10<⊕ <u><</u> 0.15mm | 2 | | | |
| Minor | LED dirty, prick | 0.15<⊕ <u><</u> 0.2mm | 1 | | | |
| | | Φ>0.2mm | 0 | | | |
| | | The distance between any two spots should be > Any spot/dot/void outside of viewing area is acce | | | | |
| Minor | Protective film tilt | Not fully cover LCD | Reject | | | |
| Major | COG coating | Not fully cover ITO circuit | Reject | | | |

8. Electric Inspection

| Defect | Inspection Item | Inspection Standards | |
|--------|-----------------|----------------------|--------|
| Major | Short | | Reject |
| Major | Open | | Reject |

9. Inspection Specification of LCD

| Defect | • | ect Item | | | Ins | spection | St | andards | <u> </u> | |
|-------------------------------|-------------------------------|---|---|--|--|--|--|---|------------------|---------|
| | | | W | | | 0.03 | | 03 <w<0.0< td=""><td></td><td>V>0.05</td></w<0.0<> | | V>0.05 |
| | | * Glass Scratch | L | | L< | | 1 | L<3 | | Any |
| Minor | Linear Defect | * Polarizer Scratch* Fiber and Linear | ACC. NO. | 1 | | | 1 | | Reject | |
| | | material | Note | L is the | len | gth and W | is the | is the width of the de | | efect |
| | | * Foreign material | | Φ <u><</u> 0. | 1 | 0.1<⊕ <u><</u> 0 | .15 |).15<⊕ <u><</u> 0 | .2 | Φ>0.2 |
| | Black Spot and | between glass and polarizer or glass | ACC. NO. | 3EA / 100mn | / n² | 2 | | 1 | | 0 |
| Minor | Polarizer Pricked | and glass * Polarizer hole or protuberance by external force | LINOIE | Φ is the average diameter of the defect. Distance between two defects > 10mm. | | | | | | |
| | | * Unobvious | Φ | Ф | Þ <u><</u> 0 | 0.3 | 0.3 | <⊕ <u><</u> 0.5 | 0. | 5<⊕ |
| | White Spot | transparant foreign material between | ACC. NO. | 3EA | / 10 | 00mm ² | | 1 | | 0 |
| Minor and Bubble in polarizer | | glass and glass or glass and polarizer * Air protuberance between polarizer and glass | | | Φ is the average diameter of the defect. Distance between two defects > 10mm. | | | | | |
| | | | Φ | Φ <u><</u> 0.1 | 0 | 0.10<⊕ <u><</u> | 0.20 | 20 0.20<Φ <u><</u> 0.25 | | Ф>0.25 |
| | | W 1 | | 3EA / 100mm | 2 m ² 2 | | 1 | | 0 | |
| Minor | Segment Defect | · W | | W is mo | ore | than 1/2 s | egme | nt width | | Reject |
| | | W. | Note | $\Phi = \frac{L + W}{2}$ Distance between two defect is 10mm | | | | | | |
| | | | Φ | Φ <u><</u> 0.1 | 0 0.10<Φ <u><</u> 0 | | | | <u><</u> 0.25 | Φ>0.25 |
| N dia a s | Protuberant | w L | W | Glue | | W <u><</u> 1/2 S W <u><</u> 0.2 | | W <u><</u> 1/2 W <u><</u> 0. | | Ignore |
| Minor | Segment | $\Phi = (L + W)/2$ | ACC. NO. | 3EA / 100mm | n ² | 2 | 1 | | | 0 |
| | | | 1. Seg | ment | • | | | | | • |
| | | | Е | 3 | B <u><</u> | 0.4mm | 0.4 <e< td=""><td>3<u><</u>1.0mm</td><td>B>′</td><td>1.0mm</td></e<> | 3 <u><</u> 1.0mm | B>′ | 1.0mm |
| | Assembly | | B- | A | B-A<1/2B | | B- | A<0.2 | B-A | <0.25 |
| Minor | Mis-alignment | | | | | cceptable | | Acceptable Acce | | eptable |
| | | | 2. Dot Matrix | | | | | | | |
| | | | Deformation>2° | | | | Reject | | | |
| Minor | Stain on LCD Panel Surface | | Accept when stains can be wiped lightly with a soft cloth or a similar one. Otherwise, judged according to the above items: "Black spot" and "White Spot" | | | | | | | |

9. RELIABILITY

| NO. | ltem | Condition | Criterion | |
|-----|----------------------------|---|---|--|
| 1 | High Temperature Operating | 70°C, 96Hrs | | |
| 2 | Low Temperature Operating | -20℃, 96Hrs | | |
| 3 | High Humidity | 50℃, 90%RH, 96Hrs | | |
| 4 | High Temperature Storage | 80°C, 96Hrs | | |
| 5 | Low Temperature Storage | -30℃, 96Hrs | No defect in cosmetic and operational function | |
| | | Random wave | on allowable. | |
| 6 | Vibration | 10 ~ 100Hz | Total current Consumption | |
| 0 | vibration | Acceleration: 2g | should be below doub le of initial value. | |
| | | 2 Hrs per direction(X,Y,Z) | | |
| | | -20°C to 25°C to 70°C | | |
| 7 | Thermal Shock | (60Min) (5Min) (60Min) | | |
| | | 16Cycles | | |
| | CCD Tooting | Contract Discharge Voltage: +1 ~ 5kV and –1 ~ –5kV | There will be discharged ten times | |
| 8 | ESD Testing | Air Discharge Voltage: +1 ~ 8kV and –1 ~ -8kV | at every discharging voltage cycle. The voltage gap is 1kV. | |

Note: 1) Above conditions are suitable for our company standard products.

2) For restrict products, the test conditions listed as above must be revised.

10. HANDLING PRECAUTION

(1) Mounting Method

The panel of the LCD Module consists of two thin glass plates with polarizers which easily get damaged since the Module is fixed by utilizing fitting holes in the printed circuit board. Extreme care should be taken when handling the LCD Modules.

(2) Caution of LCD handling & cleaning

When cleaning the display surface, use soft cloth with solvent (recommended below) and wipe lightly.

- Isopropyl alcohol
- Ethyl alcohol
- Trichloro trifloro thane

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface. Do not use the following solvent:

- Water
- Ketone
- Aromatics

(3) Caution against static charge

The LCD Module use C-MOS LSI drivers, so we recommend that you connect any unused input terminal to VDD or VSS, do not input any signals before power is turned on. And ground your body, Work/assembly table. And assembly equipment to protect against static electricity.

(4) Packaging

- Modules use LCD elements, and must be treated as such. Avoid intense shock and falls from a height.
- To prevent modules from degradation. Do not operate or store them exposed directly to sunshine or high temperature/humidity.

(5) Caution for operation

- It is indispensable to drive LCD's within the specified voltage limit since the higher voltage than the limit shorten LCD life. An electrochemical reaction due to direct current causes LCD deterioration, Avoid the use of direct current drive.
- Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's. Which will come back in the specified operating temperature range.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the relative condition of 40°C, 50%RH or less is required.

(6) Storage

In the case of storing for a long period of time (for instance.) For years) for the purpose or replacement use, The following ways are recommended.

- Storage in a polyethylene bag with sealed so as not to enter fresh air outside in it, And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light is. Keeping temperature in the specified storage temperature range.
- Storing with no touch on polarizer surface by the anything else. (It is recommended to store them as they have been contained in the inner container at the time of delivery)

(7) Safety

- It is recommendable to crash damaged or unnecessary LCD into pieces and wash off liquid crystal by using solvents such as acetone and ethanol. Which should be burned up later.

When any liquid crystal leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

